

# *Arctic Silver*<sup>®</sup>

Thermal Compound Application Method

• Vertical Line •

## Contents

<b>Introduction</b> .....	2
A Note About Heatsinks .....	
<b>Precautions</b> .....	
<b>Application Instructions</b> .....	3-6
Heatsink Preparation .....	3
CPU Preparation .....	4
Tinting the Heatsink and Metal cap .....	4-5
Applying Thermal Compound .....	5
Attaching the Heatsink .....	5-6
Break-In Period Explained .....	6
Break-In Period By Thermal Compound .....	
<b>Storage and Clean-Up</b> .....	7
Removal From Hardware .....	
Removal From Self .....	
<b>Troubleshooting</b> .....	8

## Introduction

Thank you for purchasing an Arctic Silver thermal compound. Please read all instructions carefully before applying your new compound. While these instructions were tested using the following Arctic Silver products (Arctic Silver 5, Céramique 2 and Arctic Alumina) the vertical line method is applicable with any thermal compound used with the following CPU:

- AMD Ryzen

### **A note about heatsinks:**

If the base of your heatsink is not flat due to exposed heat-pipes or ridges, please read the Heat-Pipe Heatsink Method first:

[http://www.arcticsilver.com/pdf/hp/hphs\\_method.pdf](http://www.arcticsilver.com/pdf/hp/hphs_method.pdf)

## Precautions

### **Arctic Silver Thermal Compound Precautions:**

- 1) Don't put it in your mouth.
- 2) Keep away from children or where children can get a hold of it.
- 3) Keep it away from pets.
- 4) **Arctic Silver 5 ONLY:** While much safer than silver greases engineered for high electrical conductivity, Arctic Silver 5 thermal compound should be kept away from electrical traces, pins, and leads. Arctic Silver 5 is slightly capacitive and could cause problems if it bridged two close-proximity electrical paths.
- 5) Never turn on a computer without a heatsink properly mounted on the CPU and thermal compound between the CPU core and the heatsink. A modern high-performance CPU can be permanently damaged in less than 10 seconds without proper cooling.
- 6) Arctic Silver 5, Céramique 2 and Arctic Alumina thermal compounds are greases and have no adhesive qualities. They will never dry or set and cannot be used to glue a heatsink to a CPU core.

## Application Instructions

### **Heatsink Preparation:**

If your heatsink has thermal material or a thermal pad on it, the existing material or pad must be removed prior to applying the new thermal compound. Only the new thermal compound should be between the heatsink and the metal cap of the CPU.

NEVER use any petroleum based cleaners (WD-40, and many automotive degreasers) on the surface of a metal cap or heatsink. The oil, which is engineered to not evaporate, will fill the microscopic valleys in the metal and significantly reduce the effectiveness of any subsequently applied thermal compound.

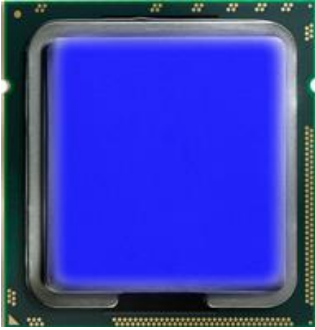
***Thermal pad removal:*** Most thermal pads are made with paraffin wax that melts once it gets hot. As it melts, the wax fills the microscopic valleys in the heatsink and metal cap of the CPU. To minimize permanent contamination of the heatsink and metal cap, the thermal pad should be removed from the heatsink prior to turning on the computer. Never use heat or hot water to remove the pad, as the heat will melt the wax into the heatsink.

Take care not to scratch the surface of the heatsink when removing the pad. A plastic tool will scrape off the thermal pad without scratching the metal surface. You can then remove the remnants of the wax with ArctiClean 1 and 2, a xylene based cleaner (Goof Off and some carburetor cleaners), or high-purity isopropyl alcohol and a LINT FREE cloth (a lens cleaning cloth or a coffee filter). If you use Goof Off or another xylene based cleaner always follow up with a cleaning of high-purity isopropyl alcohol.

***Thermal material removal:*** Remove existing thermal material with ArctiClean 1 and 2, a xylene based cleaner (Goof Off and some carburetor cleaners), or high-purity isopropyl alcohol and a LINT FREE cloth (a lens cleaning cloth or coffee filter). If you use Goof Off or another xylene based cleaner always follow up with a cleaning of high-purity isopropyl alcohol.

***Important:*** Keep the surface free of foreign materials and do NOT touch the surface after it has been cleaned. A hair, piece of lint, and even dead skin cells can significantly affect the thermal interface's performance. Oils from your fingers can adversely affect the performance by preventing the micronized silver or ceramic fill from directly contacting the metal surfaces. (Fingerprints can be as thick as 0.005")

## CPU Preparation:



QP1

The surface highlighted in blue is part of the metal cap and is covering the quad or dual cores in picture QP1. If the metal cap does not have existing thermal material on it, cleaning is not required, but is highly recommended. If any existing thermal material is on the metal cap, the surface must be cleaned prior to applying your new thermal compound.

**Thermal material removal:** Remove existing thermal material with ArctiClean 1 and 2, a xylene based cleaner (Goof Off and some carburetor cleaners), or high-purity isopropyl alcohol and a LINT FREE cloth (a lens cleaning cloth or coffee filter). If you use Goof Off or another xylene based cleaner always follow up with a cleaning of high-purity isopropyl alcohol.

**Important:** Keep the surface free of foreign materials and do NOT touch the surface after it has been cleaned. A hair, piece of lint, and even dead skin cells can significantly affect the thermal interface's performance. Oils from you fingers can adversely affect the performance by preventing the micronized silver or ceramic fill from directly contacting the metal surfaces. (Fingerprints can be as thick as 0.005")

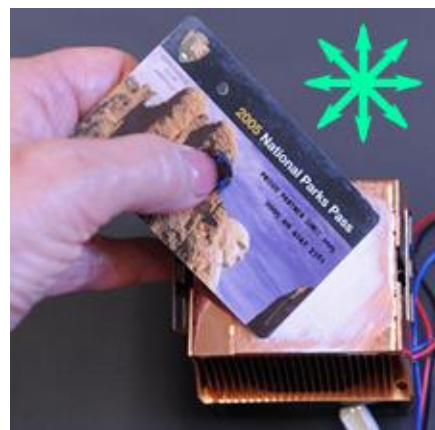
## Tinting the Heatsink and Metal cap:

Why tint the heatsink and metal cap? Simply put, it will lessen the break-in period. If the break-in period is reduced, you will achieve maximum performance in less time (To learn more about the break-in period for your Arctic Silver's product please see page 6).

Here is the list of things you will need to tint your heatsink and metal cap:

- Your new thermal compound
- An old credit card or a piece of hard plastic with a straight edge
- Coffee filter or lens cleaning cloth.

Photo HS1 shows Céramique 2 being used however, the method of tinting a heatsink or metal cap is the same for Arctic Silver 5, and Arctic Alumina. Determine what area on the base of the heatsink will contact the CPU cores once the heatsink is mounted.



HS1

Squeeze enough thermal compound onto the center of this area to create a small mound. By working the plastic tool (old credit card) back and forth in all directions (See green symbol in photo HS1) you will smooth out the compound and work it into heatsink. This will ensure optimum filling of the microscopic valleys in the metal where the CPU cores will contact the heatsink.

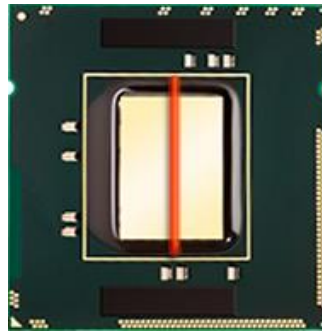
**Important!** DO NOT smooth or apply the compound with your bare finger, you will contaminate the surface (skin cells, and body oil again). After you have thoroughly worked the thermal compound into the surface of the heatsink, remove the excess compound by wiping it away with a coffee filter or a LINT FREE cloth. DO NOT use any solvent or fluid to clean the surface or you will reverse what you just accomplished. Notice that the base of the heatsink is slightly discolored even after the entire compound would seem to have been removed. The discoloring you see is the thermal compound inside the microscopic valleys of the heatsink. Now tint the surface of the metal cap the same way. You won't need to cover the entire surface of the metal cap, just cover about the size of a quarter in the center of the CPU metal cap. To get a frame of reference where the CPU cores are located see photo QP3.

### Applying Thermal Compound:

With the triangle mark on the substrate pointing down and to the left, apply a line of thermal compound to match the red line in photo QP2. Make the line approximately 1 millimeter wide. The line of thermal compound crosses the quad or dual cores vertically as shown with the metal cap removed in photo QP3. Since heat from the CPU cores travel directly through the metal cap through the compound to the heatsink, it is much more important to have a good interface directly above the cores than it is to have the metal cap covered with compound from corner to corner.



QP2



QP3



QP4

### Attaching the Heatsink:

Use your manufacturer's heatsink instructions in combination with the following suggestions: Do NOT spread the line of thermal compound out. When you place the heatsink on the top of the metal cap, the line of thermal compound will spread out like the pink oval pattern on top of the metal cap shown in photo QP4. Allowing the mounted heatsink to spread the thermal compound insures proper coverage of

the metal cap, minimizes air bubbles and allows an optimum bond line between the two surfaces. RECHECK to make sure no foreign contaminants are present on either the bottom of the heatsink or the top of the metal cap. Be sure to lower the heatsink straight down onto the metal cap. Once the heatsink is properly mounted, grasp the heatsink and very gently twist it slightly clockwise and counterclockwise one time each if possible (Just one or two degrees or so if possible). Please note that some heatsinks cannot be twisted once mounted.

Once you are finished applying thermal compound and mounting your heatsink properly, turn on your computer. Your computer should function normally. For more information on the break-in period, please see below.

If you have unusually high temperatures, please refer to the trouble shooting list on page 8 of these instructions.

### **Break-In Period Explained:**

Due to the unique carrier fluid used and the shapes and sizes of the thermally conductive particles in Arctic Silver's thermal compounds it will take multiple thermal cycles to achieve maximum particle to particle thermal conduction and for the heatsink to metal cap interface to reach maximum conductivity. (This period will be longer in a system without a fan on the heatsink.) On systems measuring actual internal core temperatures via the CPU's internal diode, the measured temperature will often drop slightly to significantly over this "break-in" period. This break-in will occur during the normal use of the computer as long as the computer is turned off from time to time and the interface is allowed to cool.

### **Break-In Period by Thermal Compound:**

#### ***Arctic Silver 5:***

Break-in period: 200 hours (Break-in period will occur during normal use.)  
Temps will drop several degrees over the break-in period measured with a thermal diode in the hottest part of the CPU core.

#### ***C ramique 2:***

Break-in period: 25 hours (Break-in period will occur during normal use.)  
Temps will drop several degrees over the break-in period measured with a thermal diode in the hottest part of the CPU core.

#### ***Arctic Alumina:***

Break-in period: 36 hours (Break-in period will occur during normal use.)  
Temps will drop several degrees over the break-in period measured with a thermal diode in the hottest part of the CPU core.

## Storage And Clean-Up

To keep your new thermal compound fresh for future applications, always replace the cap on the syringe after each use. The syringe should be stored tip down so that any separation between the particles and suspension fluid will be at the back end of the syringe. Like any mix of particles that are many times heavier than the suspension fluid, there may be some separation in the compound over time when stored in the original syringe. Storing in a cool place like a refrigerator will minimize the possibility of separation over time. This does not affect the performance of the un-separated or remixed compound.

### **Removal From Hardware:**

Thermal compound can easily be removed from hardware using the proper cleaners and tools: For general clean up, a cloth or paper towel will work well. Intricate cleaning can be accomplished with Q-tip swabs. An old toothbrush can often get the compound out of crevices that other tools cannot reach. Again, use ArctiClean 1 and 2 or high-purity isopropyl alcohol.

**CPU Core:** Remove thermal material with ArctiClean 1 and 2, a xylene based cleaner, (Goof Off and some carburetor cleaners) or high-purity isopropyl alcohol and a LINT FREE cloth (a lens cleaning cloth or coffee filter). If you use Goof Off or another xylene based cleaner always follow up with a cleaning of high-purity isopropyl alcohol.

**Heatsink:** Remove thermal material with ArctiClean 1 and 2, a xylene based cleaner, (Goof Off and some carburetor cleaners) or high-purity isopropyl alcohol and a LINT FREE cloth (a lens cleaning cloth or coffee filter). If you use Goof Off or another xylene based cleaner always follow up with a cleaning of high-purity isopropyl alcohol.

**CPU Ceramic Package:** Remove thermal compound with ArctiClean 1 and 2, a liquid dish soap (not dishwasher detergent), WD-40, Citrus based cleaners, xylene based products (Goof Off, some carburetor cleaners and many brake cleaners.) or mineral spirits. Once the majority of the compound has been removed from the ceramic, small patches remaining on the ceramic package can be 'erased' with a soft eraser.

### **Removal From Self:**

Wash your hands with any liquid soap (Dawn, Lux, Palmolive, Etc.) rather than hand soap. (Do not use detergent for an automatic dishwasher.)

## Troubleshooting

When someone gets temperature results that are the opposite of the results achieved by hundreds of thousands of other users, the problem can usually be traced to one of 12 things listed below:

1. The heatsink was cleaned with an oil based cleaner which filled the microscopic gaps and contaminated the interface.
2. The existing thermal interface material was not completely removed. The compound should be the only material between the heatsink and the CPU.
3. The heatsink was not installed properly.
4. The thermal compound was applied too thick.
5. The measurement is being taken on the cold side of the thermal junction or on the side of the core where thermal compound squeezed from the junction contaminates the probe. (Better compound then transfers more heat to the probe so the temperature reads higher.)
6. The measurement probe moved when the chip was removed to clean off the previous compound.
7. The compound was not allowed to go through its break-in period. (Minimum 25 hours. Can be 400+ hours.) Temperatures will drop 1C to 5C over this time.
8. The application was contaminated with an eyelash, a bit of dirt, fingerprint or something else that spaced the heatsink away from the metal cap.
9. An unbalanced heatsink fan is causing excessive vibration and damaging the interface layer.
10. An improperly manufactured or bent shim is interfering with proper contact between the CPU core and the heatsink.
11. The heatsink fan was not plugged back in after the compound was changed.
12. The ambient temperature where the computer is located has changed. If the room temperature changes, the CPU temperature will also change. It is important to remember that cooling solutions keep the CPU X number of degrees above ambient. So if the ambient temperature increases 3 degrees, the CPU temperature will also increase 3 degrees.